

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHRISTIAN BOEMLER	08/24/2004
RECEIVING PARTY DATA	
Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
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State/Country:	IDAHO
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PROPERTY NUMBERS Total: 2	
Property Type	Number
Patent Number:	7265706
Patent Number:	7330146
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ATTORNEY DOCKET NUMBER:	APT2003-0820D01_D02
NAME OF SUBMITTER:	SHARRON CASTILLO
SIGNATURE:	/Sharron Castillo/
DATE SIGNED:	11/22/2016
Total Attachments: 2	
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ASSIGNMENT AND AGREEMENT

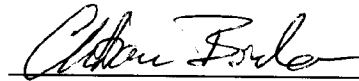
For value received, I, Christian Bocmler, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled MINIMIZED SAR-TYPE COLUMN-WIDE ADC FOR IMAGE SENSORS, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

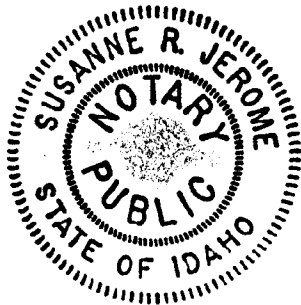
I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

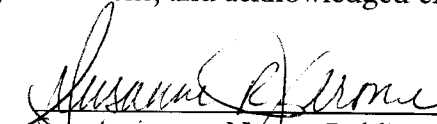

Christian Boemler

Date: 8/27/04

United States of America)
State of IDAHO) ss.:
County of ADA)

On this 27th day of August, 2004, before me personally came Christian Boemler, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.




exp. 3/12/08 Notary Public